Specification of Thermoelectric Module

TEC1-09706

Description

The 97 couples, 30 mm × 30 mm size porch type module which is made of selected high performance ingot to achieve superior cooling performance and greater delta T up to 70 °C, designed for superior cooling and heating up to 100/200 °C applications. If higher operation or processing temperature is required, please specify, we can design and manufacture the custom made module according to your special requirements.

Features

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

Application

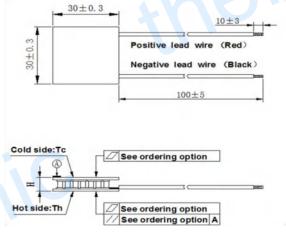
- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

Performance Specification Sheet

Th (°C)	27	50	Hot side temperature at environment: dry air, N ₂
DT _{max} (°C)	70	79	Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side
U _{max} (Voltage)	12.2	13.2	Voltage applied to the module at DT _{max}
I _{max} (amps)	6.0	6.0	DC current through the modules at DT _{max}
Q _{Cmax} (Watts)	46.1	49.7	Cooling capacity at cold side of the module under DT=0 °C
AC resistance (ohms)	1.55	1.67	The module resistance is tested under AC
Tolerance (%)	± 10		For thermal and electricity parameters

A. Solder:

Geometric Characteristics Dimensions in millimeters



Manufacturing Options

0	-

1. T100: BiSn (Tmelt=138°C) 1. NS: No sealing (Standard)

B. Sealant:

2. T200: CuAgSn (Tmelt = 217°C) 2. SS: Silicone sealant

3. T240: SbSn (Tmelt = 240°C) 3. EPS: Epoxy sealant

C. Ceramics: D. Ceramics Surface Options:

1. Alumina (Al₂O₃, white 96%)

1. Blank ceramics (not metalized)

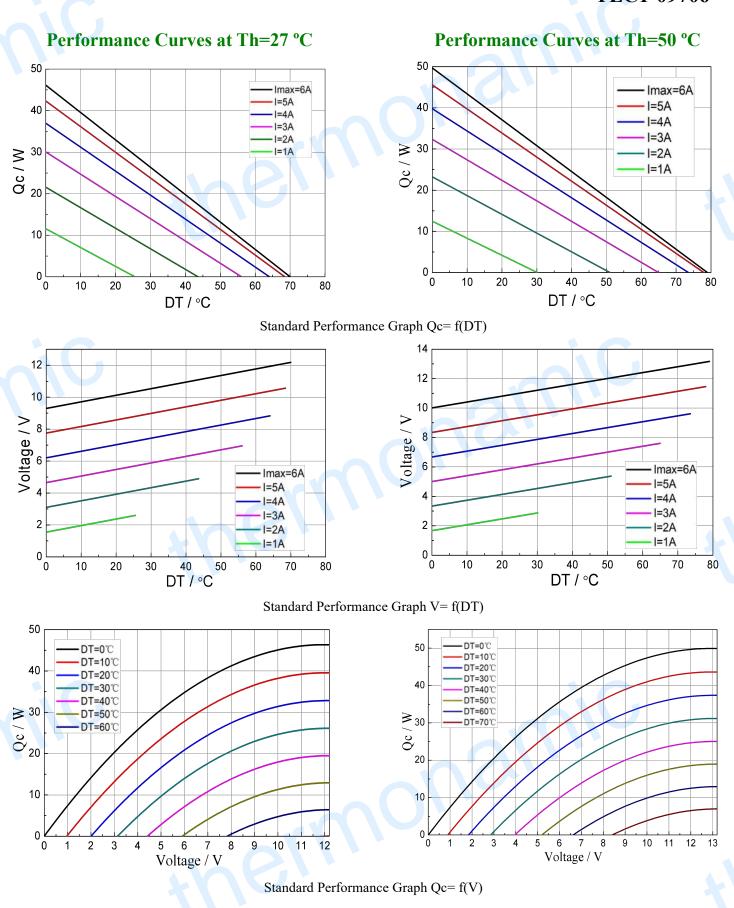
2. Aluminum Nitride (AlN) 2. Metalized

Ordering Option

Suffix Thickness H (mm)	Thickness	Flotness/ Povellelism (mm)	Lead wire length(mm)			
	H (mm)	Flatness/ Parallelism (mm)	Standard/Optional length			
TF	$0:3.95 \pm 0.1$	0:0.07/0.07	100±5/Specify			
TF	1:3.95±0.03	1:0.025/0.025	100±5/Specify			
Eg. TF00: Thickness 3.95 ± 0.1 (mm) and Flatness $0.07/0.07$ (mm)						

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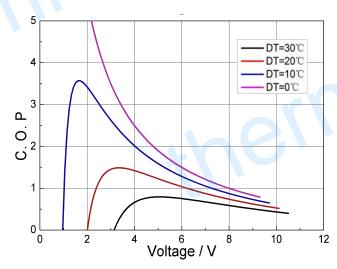
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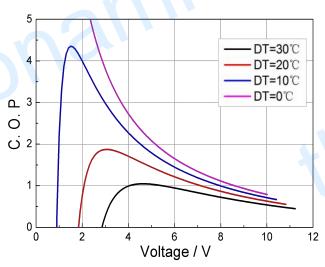
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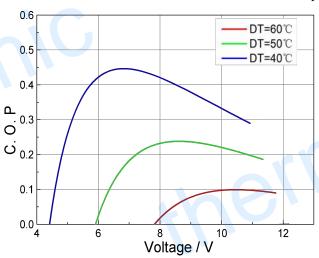
Performance Curves at Th=27 °C

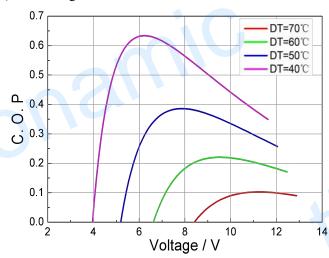


Performance Curves at Th=50 °C



Standard Performance Graph COP = f(V) of DT ranged from 0 to 30 °C





Standard Performance Graph COP = f(V) of DT ranged from 40 to 60/70 °C

Remark: The coefficient of performance (COP) is the cooling power Qc/Input power ($V \times I$).

Operation Cautions

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating
- Operation below I_{max} or V_{max}
- Work under DC

Note: All specifications subject to change without notice.